

L Number	Hits	Search Text	DB	Time stamp
2	118252	byproduct or by-product or (by adj1 product)	USPAT; US-PGPUB	2004/07/12 15:12
3	691243	wafer or substrate	USPAT; US-PGPUB	2004/07/12 11:34
4	2148961	remove\$2 or remov\$4	USPAT; US-PGPUB	2004/07/12 11:34
5	681	(byproduct or by-product or (by adj1 product)) with (wafer or substrate) with (remove\$2 or remov\$4)	USPAT; US-PGPUB	2004/07/12 11:36
8	1087700	helium or he or inert or carrier	USPAT; US-PGPUB	2004/07/12 15:12
16	95	((byproduct or by-product or (by adj1 product)) with (wafer or substrate) with (remove\$2 or remov\$4)) same (helium or he or inert or carrier)	USPAT; US-PGPUB	2004/07/12 14:02
18	41421	byproduct or by-product or (by adj1 product)	EPO; JPO; DERWENT; IBM_TDB	2004/07/12 15:12
19	750104	helium or he or inert or carrier	EPO; JPO; DERWENT; IBM_TDB	2004/07/12 15:12
20	9	(byproduct or by-product or (by adj1 product)) and (helium or he or inert or carrier) and (wafer and substrate)	EPO; JPO; DERWENT; IBM_TDB	2004/07/12 15:13

L Number	Hits	Search Text	DB	Time stamp
2	118252	byproduct or by-product or (by adj1 product)	USPAT; US-PGPUB	2004/07/12 15:12
3	691243	wafer or substrate	USPAT; US-PGPUB	2004/07/12 11:34
4	2148961	remove\$2 or remov\$4	USPAT; US-PGPUB	2004/07/12 11:34
5	681	(byproduct or by-product or (by adj1 product)) with (wafer or substrate) with (remove\$2 or remov\$4)	USPAT; US-PGPUB	2004/07/12 11:36
8	1087700	helium or he or inert or carrier	USPAT; US-PGPUB	2004/07/12 15:12
16	95	((byproduct or by-product or (by adj1 product)) with (wafer or substrate) with (remove\$2 or remov\$4)) same (helium or he or inert or carrier)	USPAT; US-PGPUB	2004/07/12 14:02
18	41421	byproduct or by-product or (by adj1 product)	EPO; JPO; DERWENT; IBM_TDB	2004/07/12 15:12
19	750104	helium or he or inert or carrier	EPO; JPO; DERWENT; IBM_TDB	2004/07/12 15:12
20	9	(byproduct or by-product or (by adj1 product)) and (helium or he or inert or carrier) and (wafer and substrate)	EPO; JPO; DERWENT; IBM_TDB	2004/07/12 15:13